

# 2A, 50V - 1000V High Efficient Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Glass passivated chip junction
- · Fast switching for high efficiency
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- · Freewheeling application

#### **MECHANICAL DATA**

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.090g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F</sub>	2	Α		
$V_{RRM}$	50 - 1000	V		
I <sub>FSM</sub>	50	Α		
$T_{JMAX}$	150	°C		
Package	DO-214AA (SMB)			
Configuration	Single die			









**DO-214AA (SMB)** 



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)										
PARAMETER	SYMBOL	HS 2AH	HS 2BH	HS 2DH	HS 2FH	HS 2GH	HS 2JH	HS 2KH	HS 2MH	UNIT
Marking code on the device		HS 2A	HS 2B	HS 2D	HS 2F	HS 2G	HS 2J	HS 2K	HS 2M	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	200	300	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	210	280	420	560	700	V
Forward current	I <sub>F</sub>				:	2				Α
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50				А				
Junction temperature	T <sub>J</sub>	- 55 to +150			°C					
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C					



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	80	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	HS2AH HS2BH HS2DH	I <sub>F</sub> = 2A, T <sub>J</sub> = 25°C	V <sub>F</sub>		1.0	V V V
Forward voltage <sup>(1)</sup>	HS2FH			-		V
i oiwaid voitage	HS2GH		V F	-	1.3	V
	HS2JH HS2KH			-	1.7	V
	HS2MH			-	-	V
2 (2)		T <sub>J</sub> = 25°C		-	5	μA
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	150	μA
	HS2AH	1MHz, V <sub>R</sub> = 4.0V		50 30	-	pF
	HS2BH		С		-	pF
	HS2DH				-	pF
	HS2FH				-	pF
Junction capacitance	HS2GH				-	pF
	HS2JH				-	pF
	HS2KH				-	pF
	HS2MH				-	pF
	HS2AH		t <sub>rr</sub>	-		ns
Reverse recovery time	HS2BH			-		ns
	HS2DH			- 5	50	ns
	HS2FH	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$		-		ns
	HS2GH			-		ns
	HS2JH			-	-	ns
	HS2KH			-	75	ns
	HS2MH			-		ns

#### Notes:

- Pulse test with PW = 0.3ms
- Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING			
HS2xH	DO-214AA (SMB)	3,000 / Tape & Reel			

# Notes:

1. "x" defines voltage from 50V(HS2AH) to 1000V(HS2MH)



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

3 AVERAGE FORWARD CURRENT (A) 2.5 2 1.5 1 0.5 0 25 50 75 100 150 0 125 LEAD TEMPERATURE (°C)

**Fig.2 Typical Junction Capacitance** 

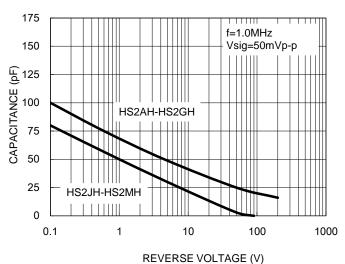
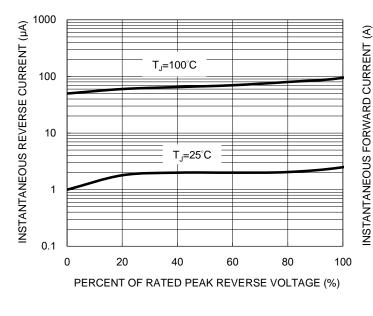
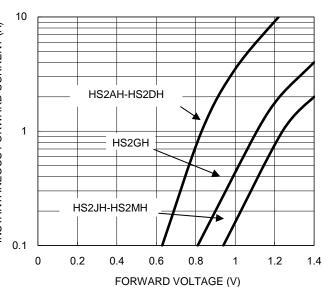


Fig.3 Typical Reverse Characteristics



**Fig.4 Typical Forward Characteristics** 

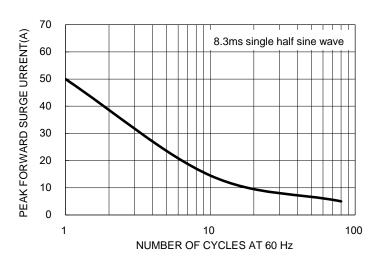




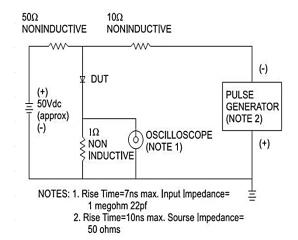
### **CHARACTERISTICS CURVES**

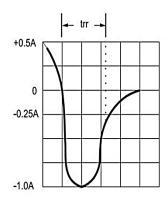
(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current



#### Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

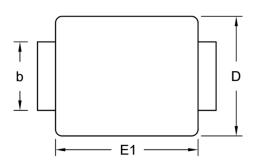


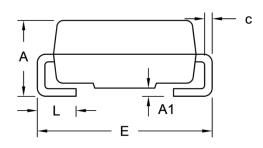




# **PACKAGE OUTLINE DIMENSIONS**

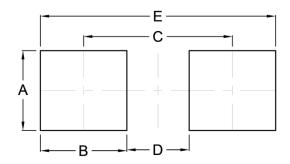
# DO-214AA (SMB)





DIM.	Unit	(mm)	Unit (inch)		
DIW.	Min.	Max.	Min.	Max.	
Α	1.95	2.65	0.077	0.104	
A1	0.05	0.20	0.002	0.008	
b	1.95	2.20	0.077	0.087	
С	0.15	0.31	0.006	0.012	
D	3.30	3.95	0.130	0.156	
E	5.10	5.60	0.201	0.220	
E1	4.05	4.60	0.159	0.181	
L	0.75	1.60	0.030	0.063	

# SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

# **MARKING DIAGRAM**



= Marking Code= Green Compound P/N G YW = Date Code = Factory Code



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